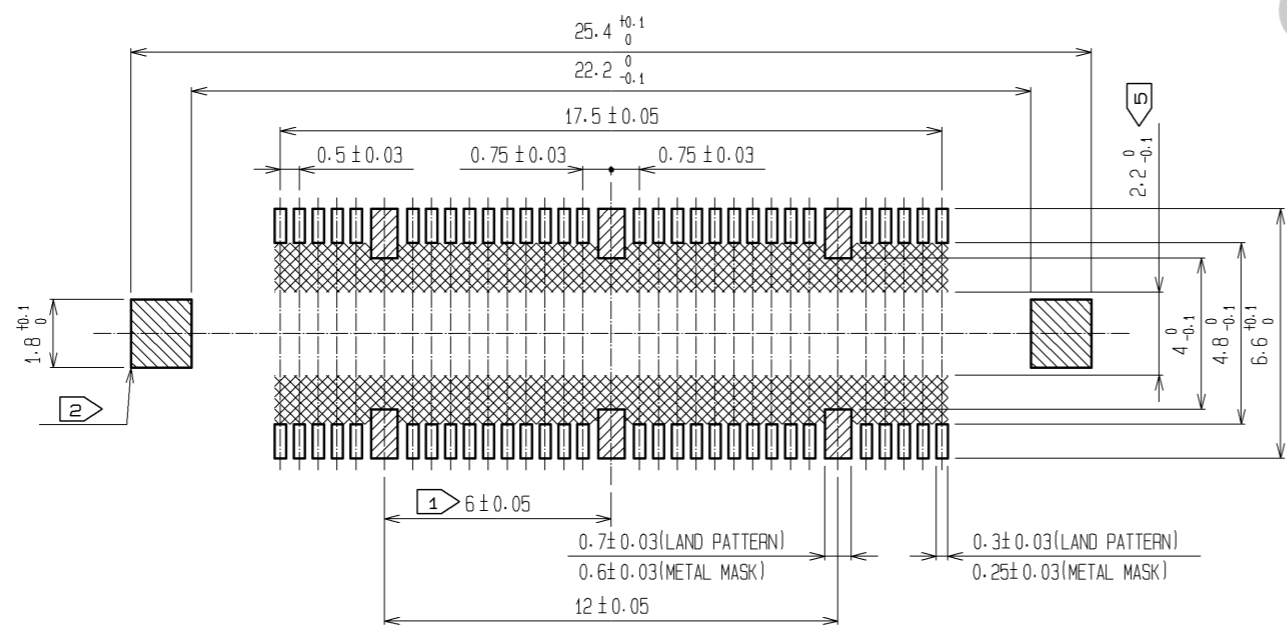


RECOMMENDED LAND PATTERN DIMENSION OF PCB



- NOTES
- ① 6 HATCHED PARTS: GROUND CIRCUIT.
 - ② 2 HATCHED PARTS: GROUND CIRCUIT.
 - ③ SMT LEAD-COPLANARITY: 0.1 MAX.
 - ④ THIS PRODUCT HAS NO POLARITY TO PATTERN FOR MOUNTING.
 - ⑤ MAKE SURE WIDTH OF PATTERN IS WITHIN THAT OF LAND. OR LEAD MAY TOUCH PATTERN. (THIS APPLIES TO HATCHED AREA.)
 - ⑥ THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCE.

4	PHOSPHOR BRONZE	TIN PLATING
3	PHOSPHOR BRONZE	TIN PLATING
2	PHOSPHOR BRONZE	CONTACT AREA : GOLD 0.1μm min.
		LEAD AREA : GOLD FLASH
		UNDER PLATING : NICKEL 1μm min.

1	LCP	BEIGE	UL94V-0				
NO.	MATERIAL	FINISH . REMARKS		NO.	MATERIAL	FINISH . REMARKS	
UNITS	mm	SCALE	5 : 1	COUNT	DESCRIPTION OF REVISIONS		DESIGNED
					APPROVED : HS. OKAWA	07.08.31	DRAWING NO.
					CHECKED : HS. OZAWA	07.08.31	PART NO.
					DESIGNED : TS. MIYAKI	07.08.30	CODE NO.
					DRAWN : TS. MIYAKI	07.08.30	
HIROSE ELECTRIC CO., LTD.				APPROVED : HS. OKAWA 07.08.31 CHECKED : HS. OZAWA 07.08.31 DESIGNED : TS. MIYAKI 07.08.30 DRAWN : TS. MIYAKI 07.08.30			
				DRAWING NO. EDC3-152112-25 PART NO. FX11LB-60S/6-SV(71) CODE NO. CL573-0112-5-71			